Peregrine Semiconductor

**SPDT UltraCMOS™ RF Switch
DC - 4000 MHz**

Product Description

The PE4245 RF Switch is designed to cover a broad range of applications from near DC to 4000 MHz. This switch integrates on-board CMOS control logic with a low voltage CMOS compatible control input. Using a +3-volt nominal power supply voltage, a 1 dB compression point of +27 dBm can be achieved. The PE4245 also exhibits excellent isolation of better than 42 dB at 1000 MHz and is offered in a small 3x3 mm DFN package.

The PE4245 is manufactured on Peregrine's UltraCMOS™ process, a patented variation of silicon-on-insulator (SOI) technology on a sapphire substrate, offering the performance of GaAs with the economy and integration of conventional CMOS.

Features

Single 3.0 V Power Supply

Low insertion loss: 0.6 dB at 1000 MHz, 0.7 dB at 2000 MHz

High isolation of 42 dB at 1000 MHz, 32 dB at 2000 MHz

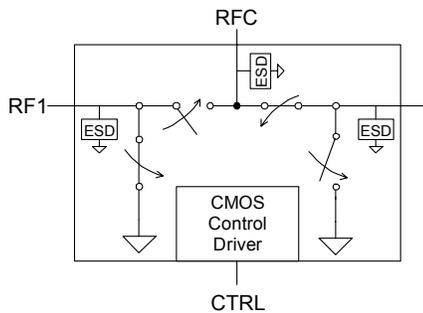Typical 1 dB compression of +27 dBm

Single-pin CMOS logic control

Available in a 6-lead DFN package

Figure 1. Functional Diagram

Figure 2. Package Type
6-lead DFN

Table 1. Electrical Specifications @ +25 °C, V_{DD} = 3 V (ZS = ZL = 50 Ω)

Parameter	Conditions	Minimum	Typical	Maximum	Units
Operation Frequency[1]		DC		4000	MHz
Insertion Loss	1000 MHz 2000 MHz		0.6 0.7	0.75 0.85	dB dB
Isolation – RFC to RF1/RF2	1000 MHz 2000 MHz	39 30	42 32		dB dB
Isolation – RF1 to RF2	1000 MHz 2000 MHz	34 27	36 29		dB dB
Return Loss	1000 MHz 2000 MHz	21 20	23 22		dB dB
'ON' Switching Time	CTRL to 0.1 dB final value, 2 GHz		200		ns
'OFF' Switching Time	CTRL to 25 dB isolation, 2 GHz		90		ns
Video Feedthrough[2]			15		mV$_{pp}$
Input 1 dB Compression	2000 MHz	26	27		dBm
Input IP3	2000 MHz, 14 dBm	43	45		dBm

Notes: 1. Device linearity will begin to degrade below 10 MHz.
2. The DC transient at the output of any port of the switch when the control voltage is switched from Low to High or High to Low in a 50 Ω test set-up, measured with 1ns risetime pulses and 500 MHz bandwidth.

Figure 3. Pin Configuration
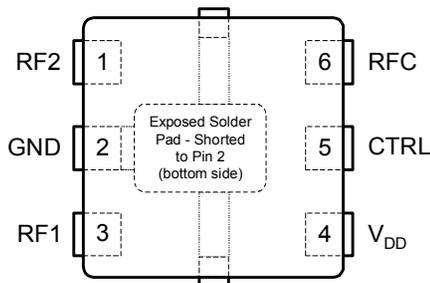
Table 2. Pin Descriptions

Pin No.	Pin Name	Description
1	RF2	RF2 port (Note 1)
2	GND	Ground Connection. Traces should be physically short and connected to the ground plane. This pin is connected to the exposed solder pad that also must be soldered to the ground plane for best performance.
3	RF1	RF1 port (Note 1)
4	V_{DD}	Nominal 3 V supply connection.
5	CTRL	CMOS logic level: High = RFC to RF1 signal path Low = RFC to RF2 signal path
6	RFC	Common RF port for switch (Note 1)

Notes: 1. All RF pins must be DC blocked with an external series capacitor or held at 0 V_{DC}.

Table 3. Operating Ranges

Parameter	Min	Typ	Max	Units
V_{DD} Power Supply Voltage	2.7	3.0	3.3	V
I_{DD} Power Supply Current V_{DD} = 3V, V_{CTRL} = 3V		250	500	nA
T_{OP} Operating temperature range	-40		85	°C
Control Voltage High	0.7x V_{DD}			V
Control Voltage Low			0.3x V_{DD}	V

Moisture Sensitivity Level

The Moisture Sensitivity Level rating for the PE4245 in the 6-lead 3x3 DFN package is MSL1.

Table 4. Absolute Maximum Ratings

Symbol	Parameter/Conditions	Min	Max	Units
V_{DD}	Power supply voltage	-0.3	4.0	V
V_I	Voltage on any input	-0.3	V_{DD}+ 0.3	V
T_{ST}	Storage temperature range	-65	150	°C
P_{IN}	Input power (50Ω)		30	dBm
V_{ESD}	ESD voltage (Human Body Model)		1500	V

Exceeding absolute maximum ratings may cause permanent damage. Operation should be restricted to the limits in the Operating Ranges table. Operation between operating range maximum and absolute maximum for extended periods may reduce reliability.

Table 5. Control Logic Truth Table

Control Voltage	Signal Path
CTRL = CMOS High	RFC to RF1
CTRL = CMOS Low	RFC to RF2

Electrostatic Discharge (ESD) Precautions

When handling this UltraCMOS™ device, observe the same precautions that you would use with other ESD-sensitive devices. Although this device contains circuitry to protect it from damage due to ESD, precautions should be taken to avoid exceeding the rating specified in Table 4.

Latch-Up Avoidance

Unlike conventional CMOS devices, UltraCMOS™ devices are immune to latch-up.

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Typical Performance Data @ 25 °C (Unless Otherwise Noted)

Figure 4. Insertion Loss - RFC to RF1
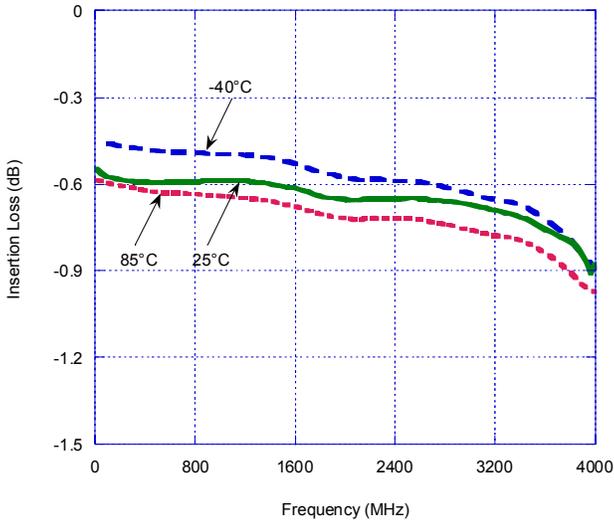   **T = -40 °C to 85 °C**

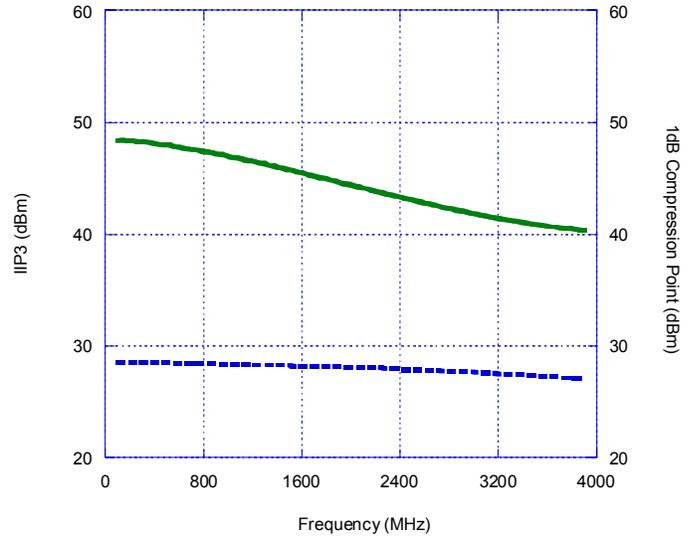**Figure 5. Input 1dB Compression Point and IIP3**

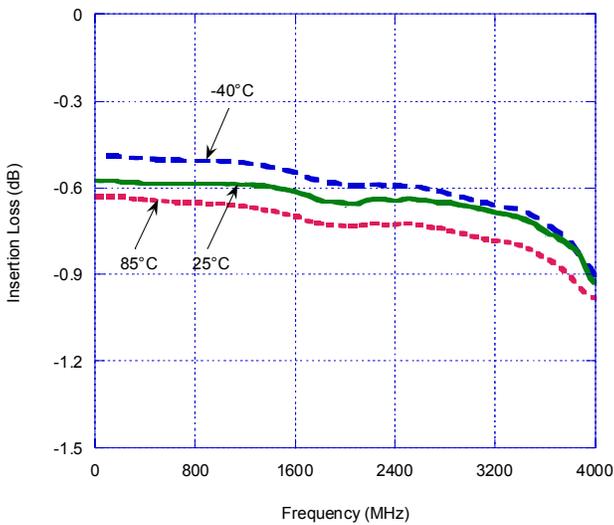**Figure 6. Insertion Loss - RFC to RF2**
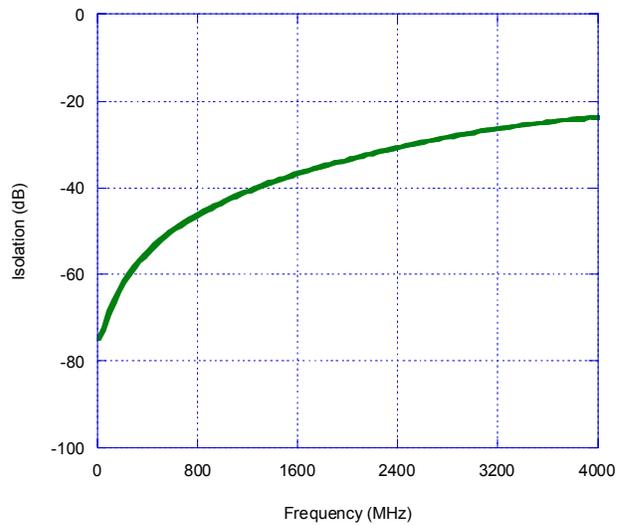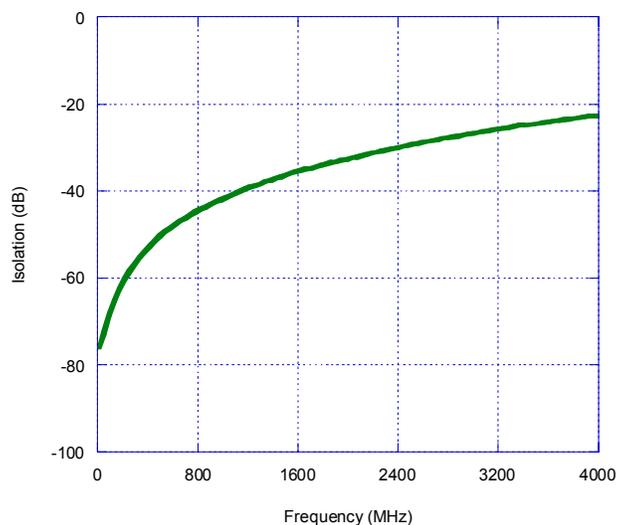   **T = -40 °C to 85 °C**
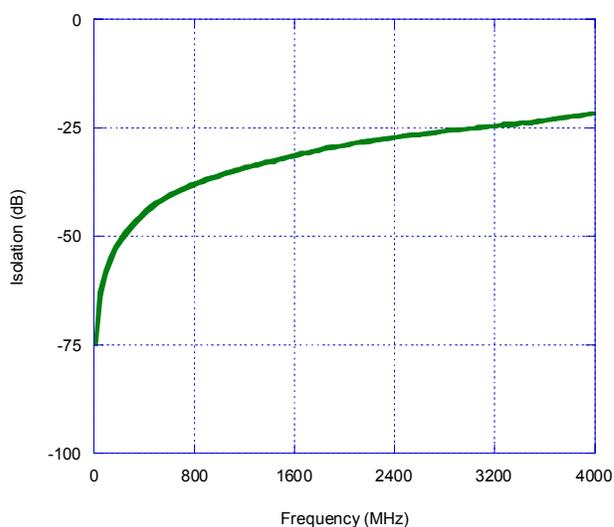

Figure 7. Isolation - RFC to RF1

Typical Performance Data @ 25 °C

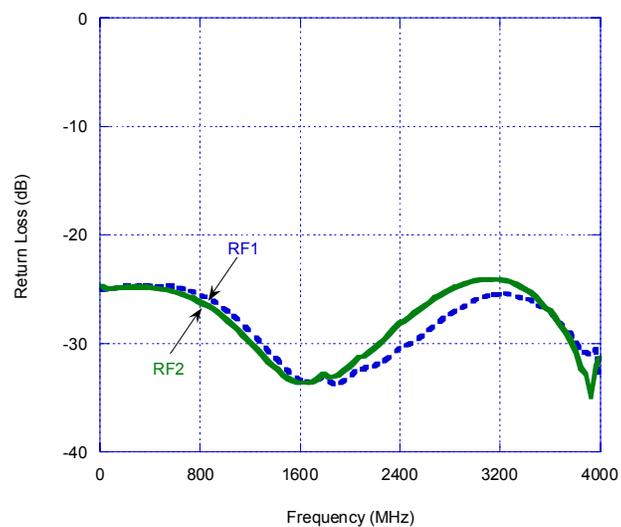### Figure 8. Isolation – RFC to RF2

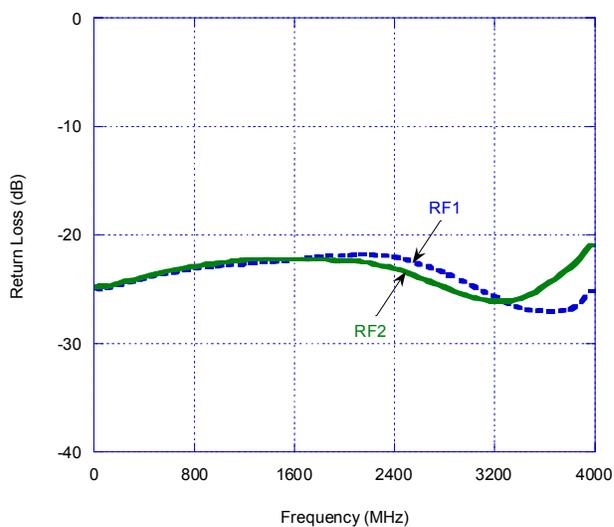### Figure 9. Isolation – RF1 to RF2, RF2 to RF1

Figure 10. Return Loss – RFC to RF1, RF2

Figure 11. Return Loss – RF1, RF2

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Evaluation Kit

The SPDT Switch Evaluation Kit board was designed to ease customer evaluation of the PE4245 SPDT switch. The RF common port is connected through a 50 Ω transmission line to the top left SMA connector, J1. Port 1 and Port 2 are connected through 50 Ω transmission lines to the top two SMA connectors on the right side of the board, J2 and J3. A through transmission line connects SMA connectors J4 and J5. This transmission line can be used to estimate the loss of the PCB over the environmental conditions being evaluated.

The board is constructed of a two metal layer FR4 material with a total thickness of 0.031". The bottom layer provides ground for the RF transmission lines. The transmission lines were designed using a coplanar waveguide with ground plane model using a trace width of 0.0476", trace gaps of 0.030", dielectric thickness of 0.028", metal thickness of 0.0021" and ε_r of 4.4.

J6 provides a means for controlling DC and digital inputs to the device. Starting from the lower left pin, the second pin to the right (J6-3) is connected to the device CTRL input. The fourth pin to the right (J6-7) is connected to the device V_{DD} input.

Figure 12. Evaluation Board Layouts
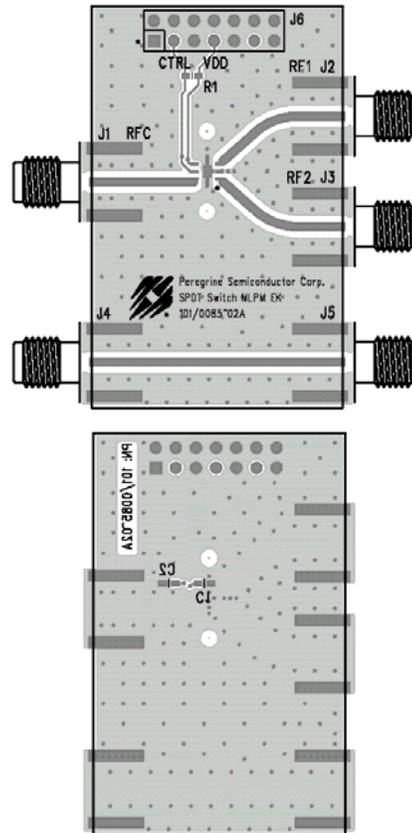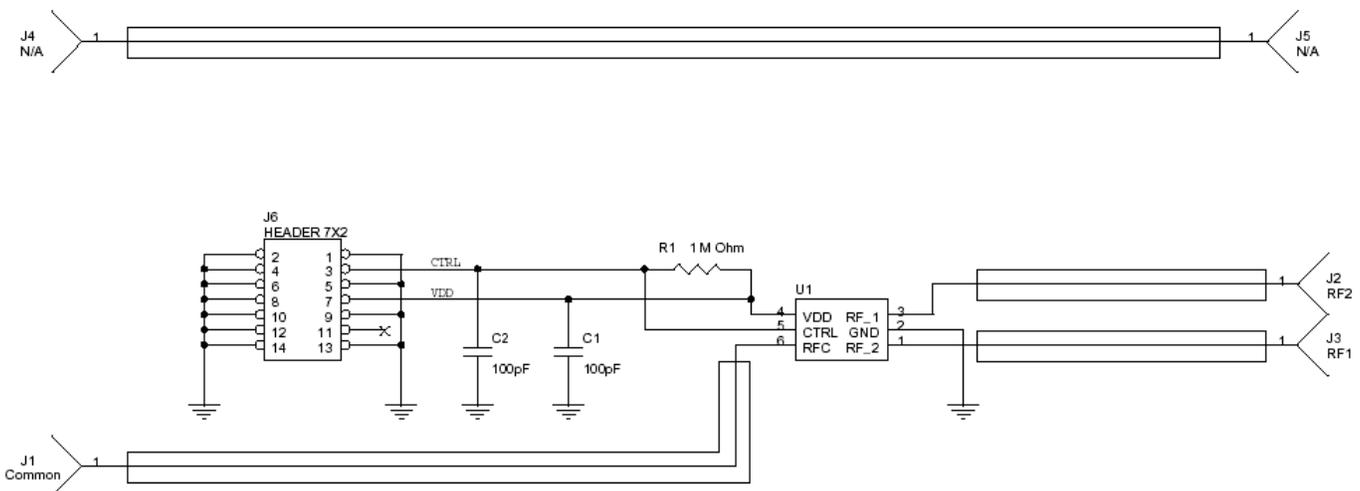Peregrine Specification 101/0085

Figure 13. Evaluation Board Schematic
Peregrine Specification 102/0110

Figure 14. Package Drawing

6-lead DFN

TOP VIEW

BOTTOM VIEW
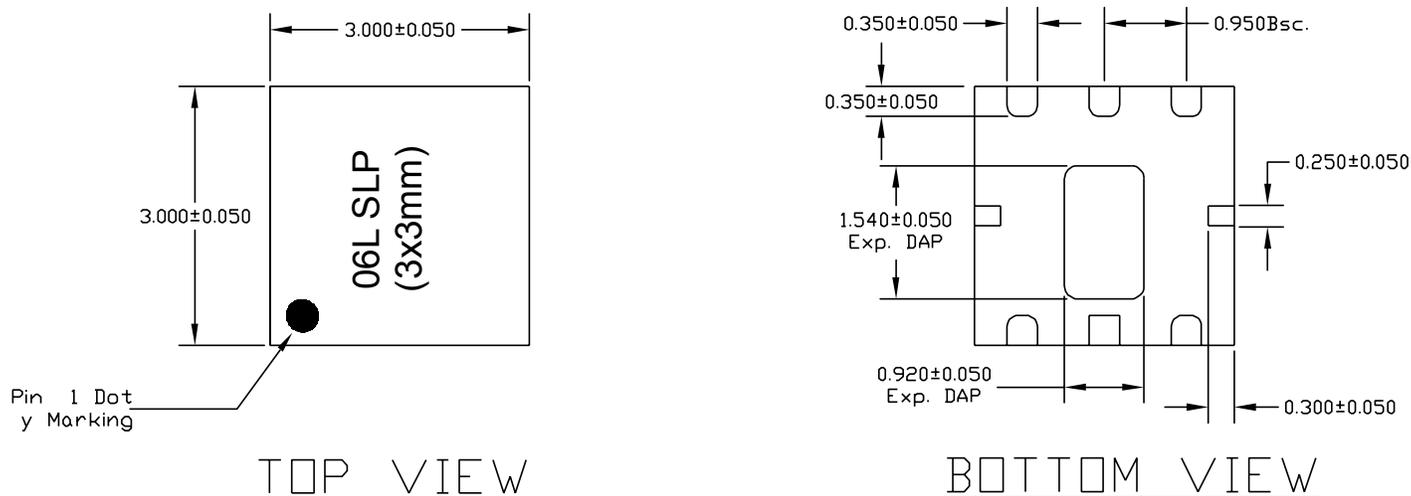
NOTE:
1) TSLP AND SLP SHARE THE SAME EXPOSE OUTLINE
   BUT WITH DIFFERENT THICKNESS:

A		TSLP	SLP
	MAX.	0.800	0.900
	NOM.	0.750	0.850
	MIN.	0.700	0.800

SIDE VIEW
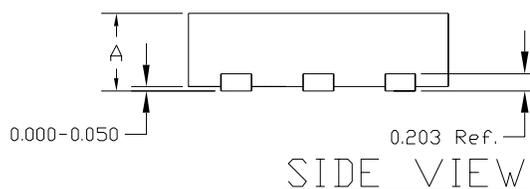
NOTE: The exposed solder pad (on the bottom of the package) is electrically connected to pin 2 (fused.)

Figure 15. Marking Specifications

4245
YYWW
ZZZZZ
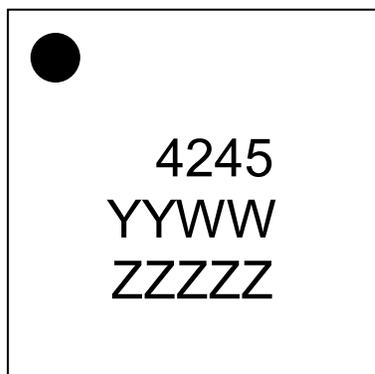
YYWW = Date Code (last two digits of year and work week)
ZZZZZ = Last five digits of Lot Number

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Figure 16. Tape and Reel Specifications

6-lead DFN

SECTION A - A

- - - - - - - ▶ Tape Feed Direction - - - - - - - ▶

Device Orientation in Tape

Table 6. Dimensions

Dimension	DFN 3x3 mm
Ao	3.23 ± 0.1
Bo	3.17 ± 0.1
Ko	1.37 ± 0.1
P	4 ± 0.1
W	8 +0.3, -0.1
T	0.254 ± 0.02
R7 Quantity	3000
R13 Quantity	N.A.

Note: R7 = 7 inch Lock Reel, R13 = 13 inch Lock Reel

NOTES:
1. 10 SPROCKET HOLE PITCH CUMULATIVE TOLERANCE ±0.2
2. CAMBER IN COMPLIANCE WITH EIA 481
3. POCKET POSITION RELATIVE TO SPROCKET HOLE MEASURED
   AS TRUE POSITION OF POCKET, NOT POCKET HOLE

Table 7. Ordering Information

Order Code	Part Marking	Description	Package	Shipping Method
4245-51	4245	PE4245G-06DFN 3x3mm-12800F	Green 6-lead 3x3 mm DFN	Tape or loose
4245-52	4245	PE4245G-06DFN 3x3mm-3000C	Green 6-lead 3x3 mm DFN	3000 units / T&R
4245-00	PE4245-EK	PE4245-06DFN 3x3mm-EK	Evaluation Kit	1 / Box

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Data Sheet Identification

Advance Information

The product is in a formative or design stage. The data sheet contains design target specifications for product development. Specifications and features may change in any manner without notice.

Preliminary Specification

The data sheet contains preliminary data. Additional data may be added at a later date. Peregrine reserves the right to change specifications at any time without notice in order to supply the best possible product.

Product Specification

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